# International Rectifier

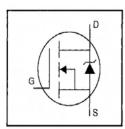
## HEXFET® Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

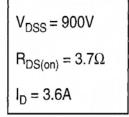
#### Description

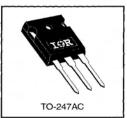
Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.



## IRFPF30PbF





### **Absolute Maximum Ratings**

	Parameter	Max.	Units	
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10 V	3.6	А	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10 V	2.3		
I <sub>DM</sub>	Pulsed Drain Current ①	14		
$P_D @ T_C = 25^{\circ}C$	Power Dissipation	125	W	
	Linear Derating Factor	1.0	W/°C	
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V	
E <sub>AS</sub>	Single Pulse Avalanche Energy ②	170	mJ	
IAR	Avalanche Current ①	3.6	A	
EAR	Repetitive Avalanche Energy ①	13	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	1.5	V/ns	
Tj	Operating Junction and	-55 to +150		
T <sub>STG</sub>	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

#### **Thermal Resistance**

Document Number: 91249

	Parameter	Min.	Тур.	Max.	Units	
Reuc	Junction-to-Case		_	1.0		
Recs	Case-to-Sink, Flat, Greased Surface	_	0.24		°C/W	
Reja	Junction-to-Ambient	_	_	40		

8/3/04

#### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	900			V	V <sub>GS</sub> =0V, I <sub>D</sub> = 250μA
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	_	1.1	_	V/°C	Reference to 25°C, Ip= 1mA
RDS(on)	Static Drain-to-Source On-Resistance	_	_	3.7	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =2.2A ④
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0	-	4.0	٧	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250μA
g <sub>fs</sub>	Forward Transconductance	2.3	_	_	S	V <sub>DS</sub> =100V, I <sub>D</sub> =2.2A ④
Ipss	Drain-to-Source Leakage Current	_	-	100	^	V <sub>DS</sub> =900V, V <sub>GS</sub> =0V
1055	Diam-to-Source Leakage Current	_		500	μА	V <sub>DS</sub> =720V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C
lgss	Gate-to-Source Forward Leakage	_	_	100	nA	V <sub>GS</sub> =20V
1055	Gate-to-Source Reverse Leakage	_	-	-100	IIA	V <sub>GS</sub> =-20V
Qg	Total Gate Charge			78		I <sub>D</sub> =3.6A
Qgs	Gate-to-Source Charge	-	_	10	пC	V <sub>DS</sub> =360V
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	-		42		V <sub>GS</sub> =10V See Fig. 6 and 13 @
td(on)	Turn-On Delay Time	_	14	_		V <sub>DD</sub> =450V
tr	Rise Time	-	25	_	ns	I <sub>D</sub> =3.6A
t <sub>d(off)</sub>	Turn-Off Delay Time	_	90	_	113	$R_{G}=12\Omega$
t <sub>f</sub>	Fall Time	-	30	_		R <sub>D</sub> =120Ω See Figure 10 @
L <sub>D</sub>	Internal Drain Inductance	_	5.0	_	nН	Between lead, 6 mm (0.25in.)
Ls	Internal Source Inductance		13	_	III	from package and center of die contact
Ciss	Input Capacitance	_	1200	_		V <sub>GS</sub> =0V
Coss	Output Capacitance	_	320	_	pF	V <sub>DS</sub> =25V
Crss	Reverse Transfer Capacitance		200			f=1.0MHz See Figure 5

#### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)		_	3.6		MOSFET symbol showing the
Ism	Pulsed Source Current (Body Diode) ①	_	_	14	A	integral reverse p-n junction diode.
VsD	Diode Forward Voltage		_	1.8	٧	T <sub>J</sub> =25°C, I <sub>S</sub> =3.6A, V <sub>GS</sub> =0V @
t <sub>rr</sub>	Reverse Recovery Time		430	650	ns	T <sub>J</sub> =25°C, I <sub>F</sub> =3.6A
Qrr	Reverse Recovery Charge		1.4	2.1	μC	di/dt=100A/μs ⑥
ton	Forward Turn-On Time	Intrinsion	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)			

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ Isp≤3.6A, di/dt≤70A/ $\mu$ s, V<sub>DD</sub>≤600 , T<sub>J</sub>≤150°C
- ②  $V_{DD}$ =50V, starting  $T_J$ =25°C, L=24mH  $R_G$ =25 $\Omega$ ,  $I_{AS}$ =3.6A (See Figure 12)
- ④ Pulse width ≤ 300 µs; duty cycle ≤2%.

## International TOR Rectifier

## IRFPF30PbF

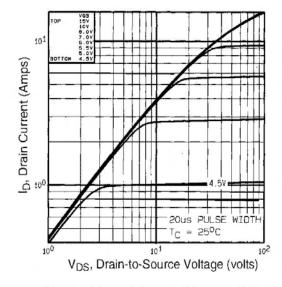


Fig 1. Typical Output Characteristics, T<sub>C</sub>=25°C

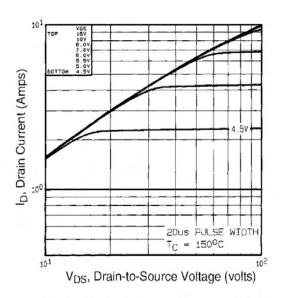


Fig 2. Typical Output Characteristics, T<sub>C</sub>=150°C

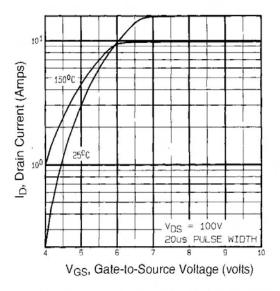
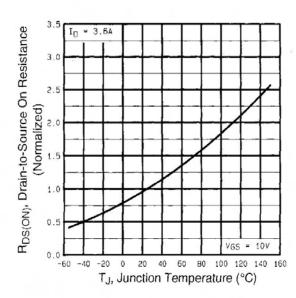
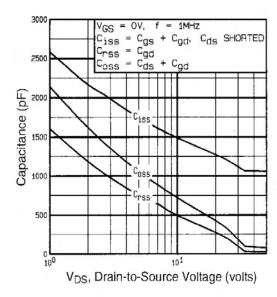


Fig 3. Typical Transfer Characteristics



**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage

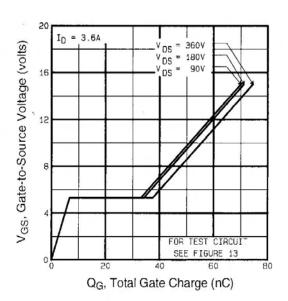


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

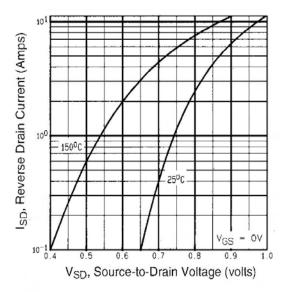


Fig 7. Typical Source-Drain Diode Forward Voltage

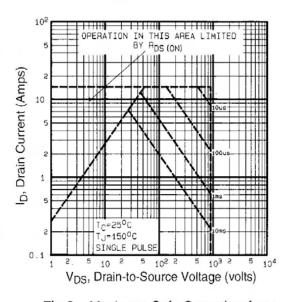


Fig 8. Maximum Safe Operating Area

## IRFPF30PbF

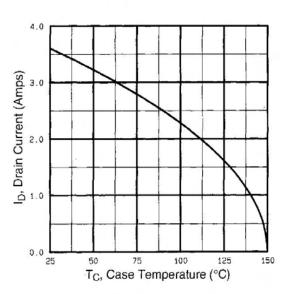


Fig 9. Maximum Drain Current Vs. Case Temperature

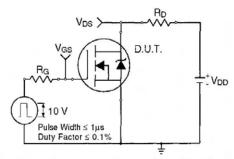


Fig 10a. Switching Time Test Circuit

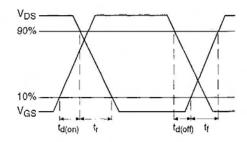


Fig 10b. Switching Time Waveforms

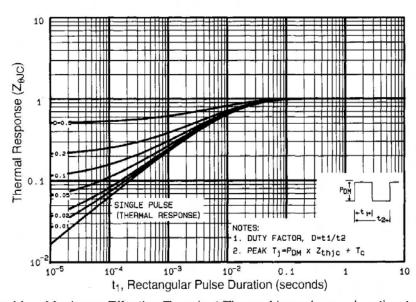


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

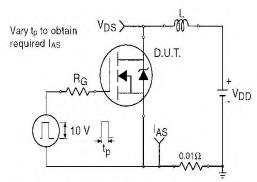


Fig 12a. Unclamped Inductive Test Circuit

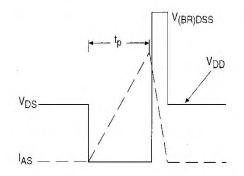


Fig 12b. Unclamped Inductive Waveforms

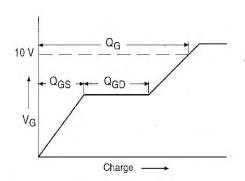


Fig 13a. Basic Gate Charge Waveform

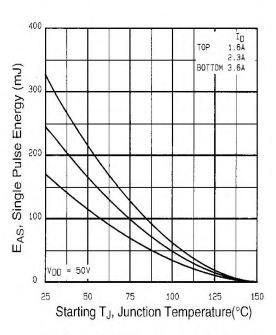


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

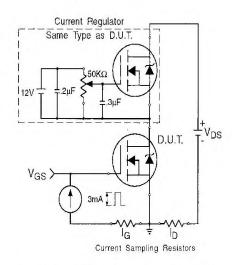
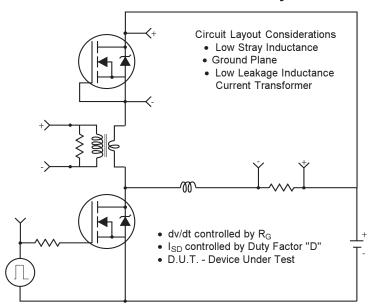


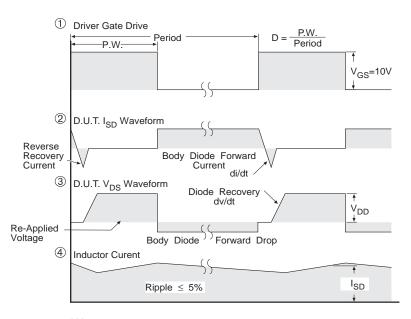
Fig 13b. Gate Charge Test Circuit

## IRFPF30PbF

## Peak Diode Recovery dv/dt Test Circuit



- \* Reverse Polarity for P-Channel
- \*\* Use P-Channel Driver for P-Channel Measurements



\*\*\*  $V_{GS}$  = 5.0V for Logic Level and 3V Drive Devices

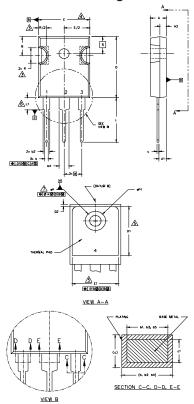
Fig -14 For N Channel HEXFETS

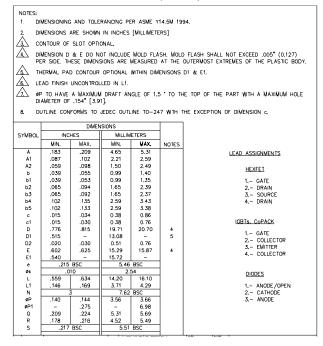
Document Number: 91249 www.vishay.com

## IRFPF30PbF

## International IR Rectifier

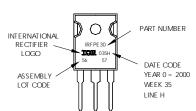
#### TO-247AC Package Outline Dimensions are shown in millimeters (inches)





## TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30 WITH ASSEMBLY LOT CODE 5657 ASSEMBLED ON WW 35, 2000 IN THE ASSEMBLY LINE "H" Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903

08/04



Vishay

### **Notice**

The products described herein were acquired by Vishay Intertechnology, Inc., as part of its acquisition of International Rectifier's Power Control Systems (PCS) business, which closed in April 2007. Specifications of the products displayed herein are pending review by Vishay and are subject to the terms and conditions shown below.

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.

International Rectifier<sup>®</sup>, IR<sup>®</sup>, the IR logo, HEXFET<sup>®</sup>, HEXSense<sup>®</sup>, HEXDIP<sup>®</sup>, DOL<sup>®</sup>, INTERO<sup>®</sup>, and POWIRTRAIN<sup>®</sup> are registered trademarks of International Rectifier Corporation in the U.S. and other countries. All other product names noted herein may be trademarks of their respective owners.

Document Number: 99901 www.vishay.com
Revision: 12-Mar-07 1